Docket No.:

P-0445A

IN THE UNITED TATES PATENT AND TRADEMARK OFFICE

In re Application of

ISSUE FEE DUE: January 11, 2006

Yong-Il KIM, Sung-Gue LEE, and Yu-Seock YANG

Serial No:

10/743,302

Group Art Unit:

2891

Confirmation No.:

7847

Examiner:

David A. ZARNEKE

Filed:

December 23, 2003

Customer No.:

34610

For:

METHOD FOR FABRICATING SEMICONDUCTOR PACKAGE AND SEMICONDUCTOR PACKAGE

U.S. Patent and Trademark Office Customer Window, MAIL STOP AF Randolph Building 401 Dulany Street Alexandria, Virginia 22314

Dear Sir:

Transmitted herewith is an Amendment under 37 C.F.R. §1.312 in the above identified application.

No additional fee is required.

Also attached:

The fee has been calculated as shown below:

00000000000000000000000000000000000000	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	29	29		x \$50.00 =	\$
Independent Claims	3	3		x \$200.00=	\$
If multiple claims newly presented, add \$360.00				d \$360.00	
		Fee for extension of time			
		TOTAL FEE DUE			\$

_	submitted herewith.		- 	.,
	A check in the amount of \$	(Check #	_) is attached.	
\boxtimes	The Commissioner is hereby authorized	l to charge payr	ment of any fees associated with thi	is communication or credit any

overpayment, to Deposit Account No. <u>16-0607</u>, including any filing fees under 37 C.F.R. 1.16 for presentation of extra claims and any patent application processing fees under 37 C.F.R. 1.17.

Please charge my Deposit Account No. 16-0607 in the amount of \$____. An additional copy of this transmittal sheet is

P.O. Box 221200

Chantilly, VA 20153-1200 (703) 766-3701 DYK/dak

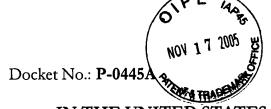
Date: November 17, 2005

Please direct all correspondence to Customer Number 34610

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Respectfully submitted
FLESHNER & KLM, LLP

Daniel Y.J. Klim
Registration No. 36,186



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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AMENDMENT UNDER 37 C.F.R. § 1.312

U.S. Patent and Trademark Office Customer Window, MAIL STOP AF Randolph Building 401 Dulany Street Alexandria, Virginia 22314

Sir:

Further to the Notice of Allowance dated **October 11, 2005**, please amend the above-identified application as follows:

Amendments to the Specification are reflected in this paper.

Remarks/Arguments begin after the listing of the claims.